XP02501 (XP2501)

Silicon NPN epitaxial planar type

For general amplification

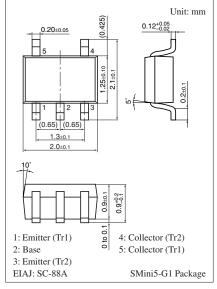
Features

- Two elements incorporated into one package (Base-coupled transistors)
- Reduction of the mounting area and assembly cost by one half

Basic Part Number

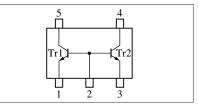
• 2SD0601A (2SD601A) × 2

Absolute Maximum Ratings $T_a = 25^{\circ}C$ Symbol Parameter Rating Unit Collector-base voltage (Emitter open) V_{CBO} 60 V Collector-emitter voltage (Base open) 50 V V_{CEO} Emitter-base voltage (Collector open) 7 V V_{EBO} Collector current 100 I_{C} mА Peak collector current I_{CP} 200 mA Total power dissipation P_T 150 mW °C Junction temperature Ti 150 Storage temperature °C T_{stg} -55 to +150



Marking Symbol: 5W

Internal Connection



Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$	60			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 2 \text{ mA}, I_{\rm B} = 0$	50			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_E = 10 \ \mu A, \ I_C = 0$	7			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 20 V, I_E = 0$			0.1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{CE} = 10 \text{ V}, I_B = 0$			100	μΑ
Forward current transfer ratio	h _{FE}	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 2 \text{ mA}$	160		460	_
h _{FE} ratio *	h _{FE(Small/}	$V_{CE} = 10 \text{ V}, I_C = 2 \text{ mA}$	0.50	0.99		—
	Large)					
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 100 \text{ mA}, I_{\rm B} = 10 \text{ mA}$		0.1	0.3	V
Transition frequency	f _T	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		3.5		pF
(Common base, input open circuited)						

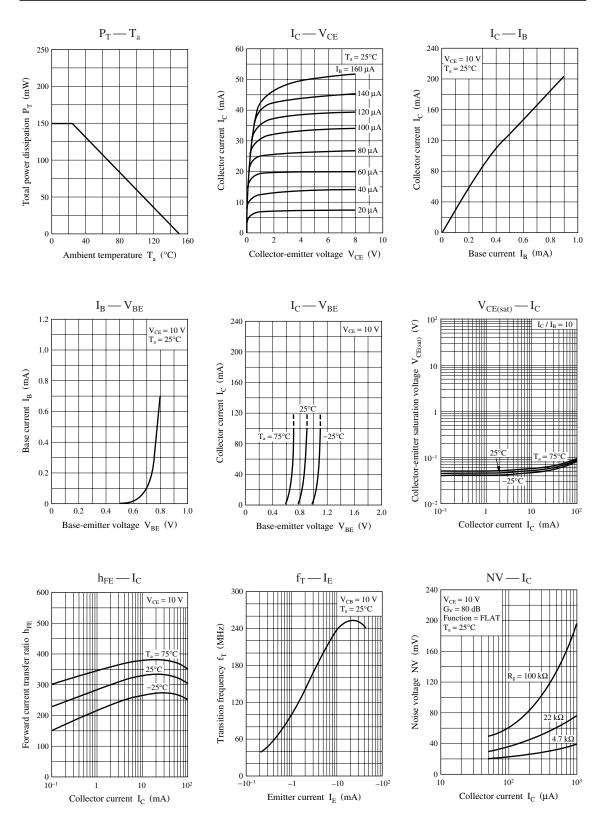
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Ratio between 2 elements

Note) The part number in the parenthesis shows conventional part number.

XP02501





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